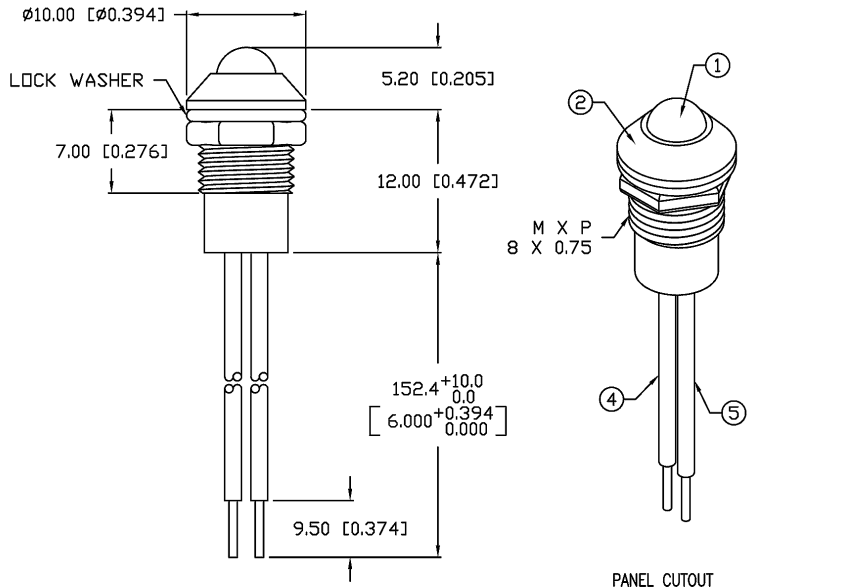


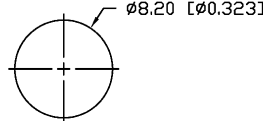
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PART NUMBER  
SSI-LXR3816SGD-150

REV.



PANEL CUTOUT



NOTES:

1. SSL-LX5093SGD, GREEN LED. TRIM LEADS TO 4mm.
2. SSI-LXR3816, CHROME HOUSING.
3. SSH-LXH4815BSG, BUSHING (NOT SHOWN), INSERT AND CRIMP.
4. ANODE LEAD: LXP-WST24RDT0C, 24 AWG., TINNED OVERCOAT, RED INSULATION. CUT 160mm LONG, STRIP BOTH ENDS 3mm & 9.5mm.
5. CATHODE LEAD: LXP-WST24BLT0C, 24 AWG., TINNED OVERCOAT, BLACK INSULATION. CUT 160mm LONG, STRIP BOTH ENDS 3mm & 9.5mm.
6. CRIMP WIRES TO LED LEADS.

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ $I_f=20\text{mA}$					
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		2.2	2.6	$V_f$	
REVERSE VOLTAGE	5.0			$V_r$	$I_r=100\mu\text{A}$
AXIAL INTENSITY		40		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		60		$2x$ theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	GREEN DIFFUSED				

LIMITS OF SAFE OPERATION AT  $25^{\circ}\text{C}$

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM $25^{\circ}\text{C}$	-1.2	$\text{mW}/^{\circ}\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^{\circ}\text{C}$

\*  $t < 10\mu\text{s}$

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X= $\pm 1$  ( $\pm 0.039$ ), X.X= $\pm 0.5$  ( $\pm 0.020$ ), X.XX= $\pm 0.25$  ( $\pm 0.010$ ), X.XXX= $\pm 0.127$  ( $\pm 0.005$ ). LEAD SIZE= $\pm 0.05$  ( $\pm 0.002$ ), LEAD LENGTH= $\pm 0.75$  ( $\pm 0.030$ ). MIN= +DECIMAL PRECISION MAX= +0.00 -DECIMAL PRECISION

UNCONTROLLED DOCUMENT

REV. PART NUMBER  
SSI-LXR3816SGD-150

T-5mm 565nm GREEN LED PANEL INDICATOR,  
SUPER GREEN DIFFUSED LENS, 6.0" WIRE LEADS.

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RELIABILITY NOTE  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



DRAWN BY: CHECKED BY: APPROVED BY: |

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